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09/582608

430 Rec'd - CT/PTO 28 JUN 2000

FORM PTO-1595
(Rev. 8-83)

10-10-2000

EET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

OMB No. 0651-0011 (exp. 4/04)



6-28-00

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101482055

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Tetsuro Nishimura

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Nihon Superior Sha Co., Ltd.

Internal Address: _____

Street Address: 16-15 Esakacho 1-chome

Suita-shi, Osaka 564-0063

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

Assignment Merger

Security Agreement Change of Name

Other _____

Execution Date: 6/16/2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)

B. Patent No.(s)

09582608

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Theodore D. Lienesch

Internal Address: Thompson Hine & Flory LLP

Street Address: 2000 Courthouse Plaza N.E.

P.O. Box 8801

City: Dayton State: Ohio ZIP: 45401-8801

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

20-0809

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct any attached copy is a true copy of the original document.

John F. Kane
Name of Person Signing

John F. Kane
Signature

6/26/00
Date

Total number of pages including cover sheet, attachments, and document: _____

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

PATENT
REEL: 011162 FRAME: 0365

ASSIGNMENT

WHEREAS, **Tetsuro Nishimura**, of the City of Osaka, Country of Japan, invented certain new and useful LEAD-FREE SOLDER ALLOY (Docket No. 550718-00071) for which I/we executed an application for letters patent of the United States;

AND WHEREAS, **Nihon Superior Sha Co., Ltd.**, a corporation of the Country of Japan, with a place of business at 16-15 Esakacho 1-chome, Suita-shi, Osaka 564-0063, hereinafter called the Assignee, is desirous of acquiring the entire right, title and interest in and to said application and the inventions therein disclosed and any letters patent that may issue thereon;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) and other valuable consideration, receipt whereof is hereby acknowledged, I/we hereby sell, assign and transfer unto said Assignee, its successors and assigns, the entire right, title and interest in and to said application and any divisions or continuations thereof, and the inventions therein disclosed, and any improvements thereon, and any patent or patents that may be issued or reissued thereon, and I/we hereby authorize and request the Commissioner of Patents and Trademarks to issue any letters patent thereon, and reissues thereof, to said Assignee, its successors and assigns; and I/we hereby authorize said Assignee, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the patent or patents issued thereon; and I/we hereby agree that, upon request, I/we will sign all papers, and make all rightful oaths, and do all acts which said Assignee, its successors or assigns, may consider necessary in connection with said United States application, and in connection with any other United States or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any patents issued or reissued thereon.

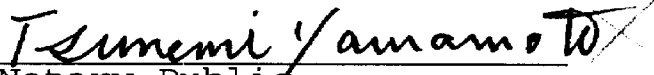
IN TESTIMONY WHEREOF, I hereunto set my hand and seal
this 12 day of June, 2000.



Tetsuro Nishimura

STATE OF _____)
) ss
COUNTY OF _____)

On this day of , 2000, before
me a Notary Public in and for the above County and State,
personally appeared the above named **Tetsuro Nishimura**,
personally known to me, and acknowledged the execution of
the foregoing assignment as a free act and deed for the
purpose herein set forth.



Notary Public

107479.2

Registered No. **273**

NOTARIAL CERTIFICATE

This is to certify that Tetsuro Nishimura has
affixed his signature in my very presence to
the attached document.

JUN. 16. 2000

Osaka Legal Affairs Bureau

Notary Tsunemi Yamamoto

Tsunemi Yamamoto

7-18 Shibata 2-chome Kita-Ku Osaka Japan

802582100

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登簿番号 平成12年 第 273 号

嘱託人 西村 哲郎 は、

当公証人の面前で、この証書に

署名 した。

よつてこれを認証する。

平成12年6月16日 当公証人役場において。

大阪法務局所属

大阪市北区芝田2丁目7番18号

公証人

山本 桂子



09/582608

430 Rec'd PCT/PTO 28 JUN 2000

号 879 業 平 21 号 番 載 登

お け せ 林 西 入 信 和

二 書 証 の こ じ 前 面 の 入 証 公 産

た じ 入 証

ふ せ 証 跡 さ け こ じ じ

は 二 象 類 公 産 証 跡

業 西 信 和 大

号 81 番 目 下 田 芝 園 北 市 大

入 証 公

大 田 芝 園 北 市 大